January 2008

74AC299, 74ACT299
8-Input Universal Shift/Storage Register with Common Parallel I/O Pins

Features

- I_{CC} and I_{OZ} reduced by 50%
- Common parallel I/O for reduced pin count
- Additional serial inputs and outputs for expansion
- Four operating modes: shift left, shift right, load and store
- 3-STATE outputs for bus-oriented applications
- Outputs source/sink 24mA
- ACT299 has TTL-compatible inputs

General Description

The AC/ACT299 is an 8-bit universal shift/storage register with 3-STATE outputs. Four modes of operation are possible: hold (store), shift left, shift right and load data. The parallel load inputs and flip-flop outputs are multiplexed to reduce the total number of package pins. Additional outputs are provided for flip-flops Q_0, Q_7 to allow easy serial cascading. A separate active LOW Master Reset is used to reset the register.

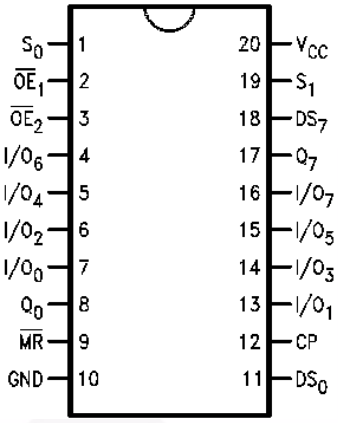
Ordering Information

Order Number	Package Number	Package Description
74AC299SC	M20B	20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide
74AC299SJ	M20D	20-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
74AC299MTC	MTC20	20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
74AC299PC	N20A	20-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide
74ACT299SC	M20B	20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide
74ACT299MTC	MTC20	20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
74ACT299PC	N20A	20-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide

Device also available in Tape and Reel. Specify by appending suffix letter “X” to the ordering number.

All packages are lead free per JEDEC: J-STD-020B standard.

Connection Diagram



Pin Description

Pin Names	Description
CP	Clock Pulse Input
DS_0	Serial Data Input for Right Shift
DS_7	Serial Data Input for Left Shift
S_0, S_1	Mode Select Inputs
$\overline{MR}$	Asynchronous Master Reset
$\overline{OE}_1$, $\overline{OE}_2$	3-STATE Output Enable Inputs
I/O_0–I/O_7	Parallel Data Inputs or 3-STATE Parallel Outputs
Q_0, Q_7	Serial Outputs

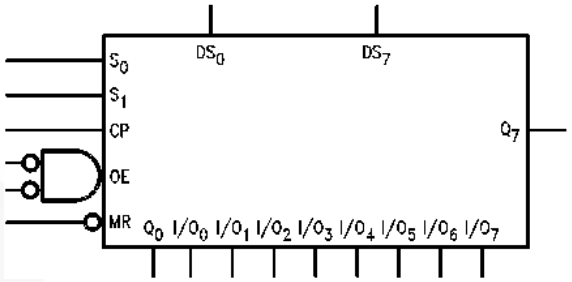
Functional Description

The AC/ACT299 contains eight edge-triggered D-type flip-flops and the interstage logic necessary to perform synchronous shift left, shift right, parallel load and hold operations. The type of operation is determined by S_0 and S_1, as shown in the Truth Table. All flip-flop outputs are brought out through 3-STATE buffers to separate I/O pins that also serve as data inputs in the parallel load mode. Q_0 and Q_7 are also brought out on other pins for expansion in serial shifting of longer words.

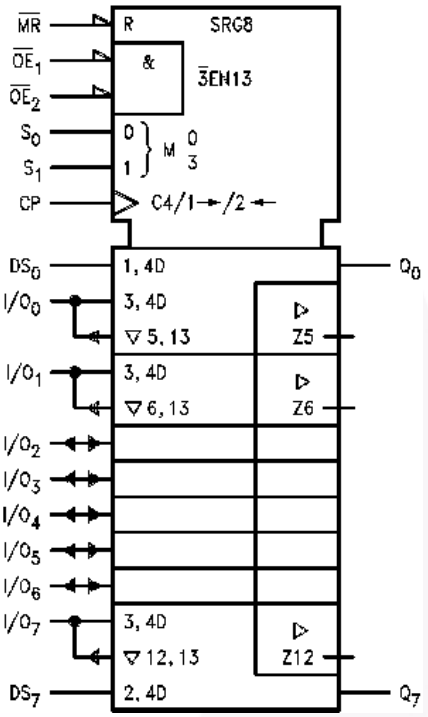
A LOW signal on $\overline{MR}$ overrides the Select and CP inputs and resets the flip-flops. All other state changes are initiated by the rising edge of the clock. Inputs can change when the clock is in either state provided only that the recommended setup and hold times, relative to the rising edge of CP, are observed.

A HIGH signal on either $\overline{OE}_1$ or $\overline{OE}_2$ disables the 3-STATE buffers and puts the I/O pins in the high impedance state. In this condition the shift, hold, load and reset operations can still occur. The 3-STATE buffers are also disabled by HIGH signals on both S_0 and S_1 in preparation for a parallel load operation.

Logic Symbols



IEEE/IEC



Truth Table

Inputs				Response
$\overline{MR}$	S_1	S_0	CP	
L	X	X	X	Asynchronous Reset; Q_0–Q_7 = LOW
H	H	H	↗	Parallel Load; $I/O_n \rightarrow Q_n$
H	L	H	↗	Shift Right; $DS_0 \rightarrow Q_0$, $Q_0 \rightarrow Q_1$, etc.
H	H	L	↗	Shift Left, $DS_7 \rightarrow Q_7$, $Q_7 \rightarrow Q_6$, etc.
H	L	L	X	Hold

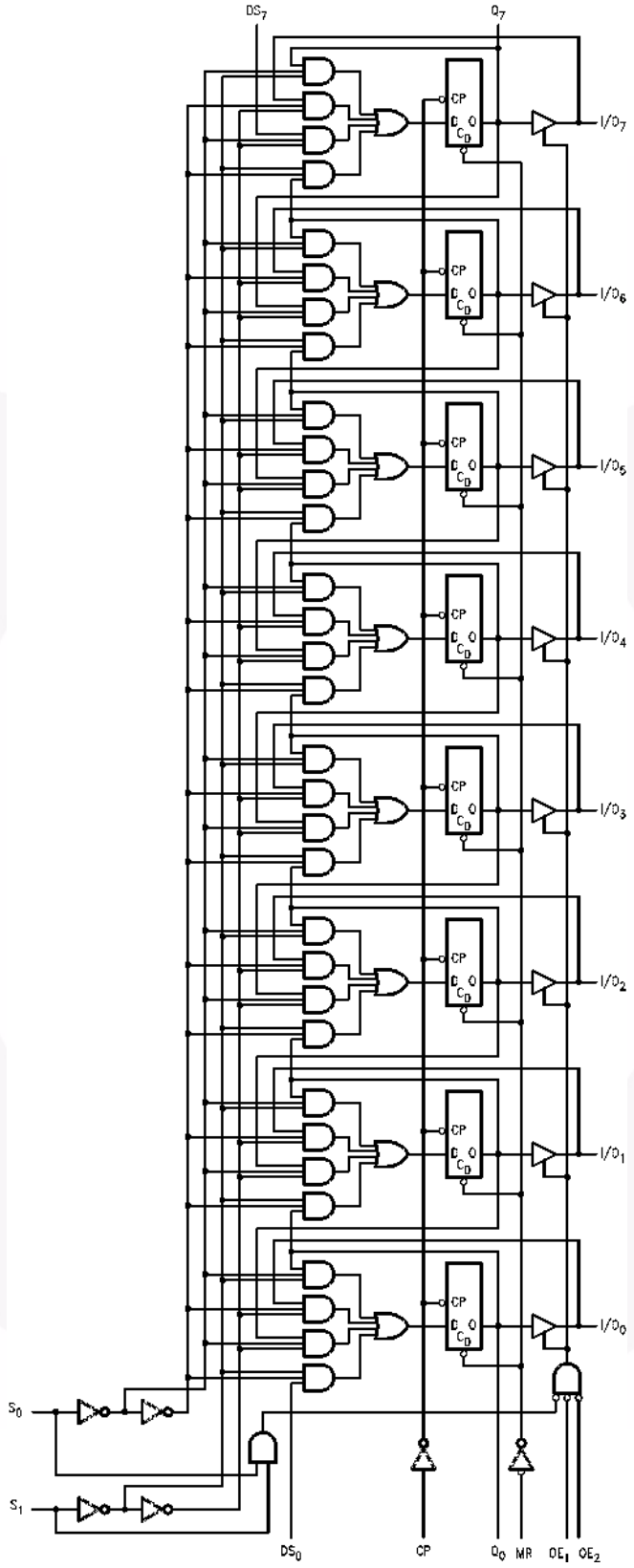
H = HIGH Voltage Level

L = LOW Voltage Level

X = Immaterial

↗ = LOW-to-HIGH Transition

Logic Diagram



Please note that this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Rating
V_{CC}	Supply Voltage	–0.5V to +7.0V
I_{IK}	DC Input Diode Current	
	$V_I = –0.5V$	–20mA
	$V_I = V_{CC} + 0.5$	+20mA
V_I	DC Input Voltage	–0.5V to V_{CC} + 0.5V
I_{OK}	DC Output Diode Current	
	$V_O = –0.5V$	–20mA
	$V_O = V_{CC} + 0.5V$	+20mA
V_O	DC Output Voltage	–0.5V to V_{CC} + 0.5V
I_O	DC Output Source or Sink Current	±50mA
I_{CC} or I_{GND}	DC V_{CC} or Ground Current per Output Pin	±50mA
T_{STG}	Storage Temperature	–65°C to +150°C
T_J	Junction Temperature	140°C

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter	Rating
V_{CC}	Supply Voltage (unless otherwise specified)	
	AC	2.0V to 6.0V
	ACT	4.5V to 5.5V
V_I	Input Voltage	0V to V_{CC}
V_O	Output Voltage	0V to V_{CC}
T_A	Operating Temperature	–40°C to +85°C
$\Delta V / \Delta t$	Minimum Input Edge Rate, AC Devices:	125mV/ns
	V_{IN} from 30% to 70% of V_{CC}, V_{CC} @ 3.3V, 4.5V, 5.5V	
$\Delta V / \Delta t$	Minimum Input Edge Rate, ACT Devices:	125mV/ns
	V_{IN} from 0.8V to 2.0V, V_{CC} @ 4.5V, 5.5V	

DC Electrical Characteristics for AC

Symbol	Parameter	V_{CC} (V)	Conditions	$T_A = +25°C$	$T_A = -40°C$ to $+85°C$		Units
				Typ.	Guaranteed Limits		
V_{IH}	Minimum HIGH Level Input Voltage	3.0	V_{OUT} = 0.1V or V_{CC} – 0.1V	1.5	2.1	2.1	V
		4.5		2.25	3.15	3.15	
		5.5		2.75	3.85	3.85	
V_{IL}	Maximum LOW Level Input Voltage	3.0	V_{OUT} = 0.1V or V_{CC} – 0.1V	1.5	0.9	0.9	V
		4.5		2.25	1.35	1.35	
		5.5		2.75	1.65	1.65	
V_{OH}	Minimum HIGH Level Output Voltage	3.0	I_{OUT} = –50µA	2.99	2.9	2.9	V
		4.5		4.49	4.4	4.4	
		5.5		5.49	5.4	5.4	
		3.0	$V_{IN} = V_{IL}$ or V_{IH}, I_{OH} = –12mA		2.56	2.46	
		4.5	$V_{IN} = V_{IL}$ or V_{IH}, I_{OH} = –24mA		3.86	3.76	
		5.5	$V_{IN} = V_{IL}$ or V_{IH}, I_{OH} = –24mA(1)		4.86	4.76	
V_{OL}	Maximum LOW Level Output Voltage	3.0	I_{OUT} = 50µA	0.002	0.1	0.1	V
		4.5		0.001	0.1	0.1	
		5.5		0.001	0.1	0.1	
		3.0	$V_{IN} = V_{IL}$ or V_{IH}, I_{OL} = 12mA		0.36	0.44	
		4.5	$V_{IN} = V_{IL}$ or V_{IH}, I_{OL} = 24mA		0.36	0.44	
		5.5	$V_{IN} = V_{IL}$ or V_{IH}, I_{OL} = 24mA(1)		0.36	0.44	
I_{IN}(2)	Maximum Input Leakage Current	5.5	$V_I = V_{CC}$, GND		±0.1	±1.0	µA
I_{OLD}	Minimum Dynamic Output Current(3)	5.5	V_{OLD} = 1.65V Max.			75	mA
I_{OHD}		5.5	V_{OHD} = 3.85V Min.			–75	mA
I_{CC}(2)	Maximum Quiescent Supply Current	5.5	$V_{IN} = V_{CC}$ or GND		4.0	40.0	µA
I_{OZT}	Maximum I/O Leakage Current	5.5	V_I (OE) = V_{IL}, V_{IH}; $V_I = V_{CC}$, GND; $V_O = V_{CC}$, GND		±0.3	±3.0	µA

Notes:

1. All outputs loaded; thresholds on input associated with output under test.
2. I_{IN} and I_{CC} @ 3.0V are guaranteed to be less than or equal to the respective limit @ 5.5V V_{CC}.
3. Maximum test duration 2.0ms, one output loaded at a time.

DC Electrical Characteristics for ACT

Symbol	Parameter	V_{CC} (V)	Conditions	$T_A = +25°C$	$T_A = -40°C$ to $+85°C$		Units
				Typ.	Guaranteed Limits		
V_{IH}	Minimum HIGH Level Input Voltage	4.5	V_{OUT} = 0.1V or V_{CC} – 0.1V	1.5	2.0	2.0	V
		5.5		1.5	2.0	2.0	
V_{IL}	Maximum LOW Level Input Voltage	4.5	V_{OUT} = 0.1V or V_{CC} – 0.1V	1.5	0.8	0.8	V
		5.5		1.5	0.8	0.8	
V_{OH}	Minimum HIGH Level Output Voltage	4.5	I_{OUT} = –50µA	4.49	4.4	4.4	V
		5.5		5.49	5.4	5.4	
		4.5	$V_{IN} = V_{IL}$ or V_{IH}, I_{OH} = –24mA	0.0001	3.86	3.76	
		5.5	$V_{IN} = V_{IL}$ or V_{IH}, I_{OH} = –24mA(4)		4.86	4.76	
V_{OL}	Maximum LOW Level Output Voltage	4.5	I_{OUT} = 50µA	0.001	0.1	0.1	V
		5.5		0.001	0.1	0.1	
		4.5	$V_{IN} = V_{IL}$ or V_{IH}, I_{OL} = 24mA		0.36	0.44	
		5.5	$V_{IN} = V_{IL}$ or V_{IH}, I_{OL} = 24mA(4)		0.36	0.44	
I_{IN}	Maximum Input Leakage Current	5.5	$V_I = V_{CC}$, GND		±0.1	±1.0	µA
I_{CCT}	Maximum I_{CC}/Input	5.5	$V_I = V_{CC}$ – 2.1V	0.6		1.5	mA
I_{OLD}	Minimum Dynamic Output Current(5)	5.5	V_{OLD} = 1.65V Max.			75	mA
I_{OHD}		5.5	V_{OHD} = 3.85V Min.			–75	mA
I_{CC}	Maximum Quiescent Supply Current	5.5	$V_{IN} = V_{CC}$ or GND		4.0	40.0	µA
I_{OZT}	Maximum I/O Leakage Current	5.5	V_I (OE) = V_{IL}, V_{IH}; $V_I = V_{CC}$, GND; $V_O = V_{CC}$, GND		±0.3	±3.0	µA

Notes:

4. All outputs loaded; thresholds on input associated with output under test.

5. Maximum test duration 2.0ms, one output loaded at a time.

AC Electrical Characteristics for AC

Symbol	Parameter	V_{CC} (V)[6]	$T_A = +25°C$, $C_L = 50pF$			$T_A = -40°C$ to $+85°C$, $C_L = 50pF$		Units
			Min.	Typ.	Max.	Min.	Max.	
f_{MAX}	Maximum Input Frequency	3.3	90	124		80		MHz
		5.0	130	173		105		
t_{PLH}	Propagation Delay, CP to Q_0 or Q_7 (Shift Left or Right)	3.3	8.5	14.0	20.5	7.0	22.0	ns
		5.0	5.5	9.5	14.0	4.5	15.0	
t_{PHL}	Propagation Delay, CP to Q_0 or Q_7 (Shift Left or Right)	3.3	8.5	14.5	21.5	7.0	23.0	ns
		5.0	5.5	10.0	14.5	5.0	16.0	
t_{PLH}	Propagation Delay, $\overline{CP}$ to I/O_n	3.3	9.0	14.5	20.5	7.5	22.5	ns
		5.0	6.0	10.0	14.5	5.0	16.0	
t_{PHL}	Propagation Delay, $\overline{CP}$ to I/O_n	3.3	10.0	16.0	23.0	8.5	24.5	ns
		5.0	6.5	11.0	16.0	6.0	17.5	
t_{PHL}	Propagation Delay, $\overline{MR}$ to Q_0 or Q_7	3.3	9.0	15.5	22.5	7.5	25.0	ns
		5.0	5.5	10.5	15.5	5.0	17.0	
t_{PHL}	Propagation Delay, $\overline{MR}$ to I/O_n	3.3	9.0	15.0	21.5	7.5	24.0	ns
		5.0	5.5	10.0	15.0	5.0	16.5	
t_{PZH}	Output Enable Time, $\overline{OE}$ to I/O_n	3.3	7.0	12.0	18.0	6.0	19.5	ns
		5.0	4.5	8.5	12.5	4.0	13.5	
t_{PZL}	Output Enable Time, $\overline{OE}$ to I/O_n	3.3	7.0	12.5	18.0	6.0	20.5	ns
		5.0	5.0	8.0	12.5	4.0	14.0	
t_{PHZ}	Output Disable Time, $\overline{OE}$ to I/O_n	3.3	6.5	13.0	18.5	5.5	19.5	ns
		5.0	3.5	9.5	14.0	3.0	15.0	
t_{PLZ}	Output Disable Time, $\overline{OE}$ to I/O_n	3.3	5.5	11.5	17.0	4.5	19.0	ns
		5.0	3.5	8.0	12.5	2.0	13.5	

Note:

6. Voltage range 3.3 is 3.3V ± 0.3V. Voltage range 5.0 is 5.0V ± 0.5V.

AC Operating Requirements for AC

Symbol	Parameter	V_{CC} (V)[7]	$T_A = +25°C$, $C_L = 50pF$	$T_A = -40°C$ to $+85°C$, $C_L = 50pF$		Units
			Typ.	Guaranteed Minimum		
t_S	Setup Time, HIGH or LOW, S_0 or S_1 to CP	3.3	3.0	8.0	8.5	ns
		5.0	2.0	5.0	5.5	
t_H	Hold Time, HIGH or LOW, S_0 or S_1 to CP	3.3	–3.0	0.5	0.5	ns
		5.0	–1.5	1.0	1.0	
t_S	Setup Time, HIGH or LOW, I/O_n to CP	3.3	2.0	5.5	6.0	ns
		5.0	1.0	3.5	4.0	
t_H	Hold Time, HIGH or LOW, I/O_n to CP	3.3	–2.0	0	0	ns
		5.0	–1.0	1.0	1.0	
t_S	Setup Time, HIGH or LOW, DS_0 or DS_7 to CP	3.3	2.5	6.5	7.0	ns
		5.0	1.5	4.0	4.5	
t_H	Hold Time, HIGH or LOW, DS_0 or DS_7 to CP	3.3	–2.0	0	0.5	ns
		5.0	–1.0	1.0	1.0	
t_W	CP Pulse Width, LOW	3.3	3.5	4.5	5.0	ns
		5.0	2.0	3.5	3.5	
t_W	$\overline{MR}$ Pulse Width, LOW	3.3	4.0	4.5	5.0	ns
		5.0	2.0	3.5	3.5	
t_{REC}	Recovery Time, $\overline{MR}$ to CP	3.3	0	1.5	1.5	ns
		5.0	0.5	1.5	1.5	

Note:

7. Voltage range 3.3 is 3.3V ± 0.3V. Voltage range 5.0 is 5.0V ± 0.5V.

AC Electrical Characteristics for ACT

Symbol	Parameter	V_{CC} (V)[8]	$T_A = +25°C$, $C_L = 50pF$			$T_A = -40°C$ to $+85°C$, $C_L = 50pF$		Units
			Min.	Typ.	Max.	Min.	Max.	
f_{MAX}	Maximum Input Frequency	5.0	120	170		110		MHz
t_{PLH}	Propagation Delay, CP to Q_0 or Q_7 (Shift Left or Right)	5.0	4.0	8.5	12.5	3.0	14.0	ns
t_{PHL}	Propagation Delay, CP to Q_0 or Q_7 (Shift Left or Right)	5.0	4.0	9.0	13.5	3.5	15.0	ns
t_{PLH}	Propagation Delay, CP to I/O_n	5.0	4.5	8.5	12.5	4.5	13.5	ns
t_{PHL}	Propagation Delay, CP to I/O_n	5.0	5.0	9.5	15.0	4.5	16.5	ns
t_{PHL}	Propagation Delay, $\overline{MR}$ to Q_0 or Q_7	5.0	4.0	14.0	15.0	4.0	18.0	ns
t_{PHL}	Propagation Delay, $\overline{MR}$ to I/O_n	5.0	4.0	13.0	14.5	3.5	17.5	ns
t_{PZH}	Output Enable Time, $\overline{OE}$ to I/O_n	5.0	2.5	8.0	12.0	1.5	13.0	ns
t_{PZL}	Output Enable Time, $\overline{OE}$ to I/O_n	5.0	2.0	8.0	12.0	1.5	13.5	ns
t_{PHZ}	Output Disable Time, $\overline{OE}$ to I/O_n	5.0	2.0	8.5	12.5	2.0	13.5	ns
t_{PLZ}	Output Disable Time, $\overline{OE}$ to I/O_n	5.0	2.5	8.0	11.5	2.0	12.5	ns

Note

8. Voltage range 5.0 is 5.0V ± 0.5V.

AC Operating Requirements for ACT

Symbol	Parameter	V_{CC} (V)[9]	$T_A = +25°C$, $C_L = 50pF$	$T_A = -40°C$ to $+85°C$, $C_L = 50pF$		Units
			Typ.	Guaranteed Minimum		
t_S	Setup Time, HIGH or LOW, S_0 or S_1 to CP	5.0	2.0	5.0	5.5	ns
t_H	Hold Time, HIGH or LOW, S_0 or S_1 to CP	5.0	–2.0	1.0	1.0	ns
t_S	Setup Time, HIGH or LOW, I/O_n to CP	5.0	1.5	4.0	4.5	ns
t_H	Hold Time, HIGH or LOW, I/O_n to CP	5.0	–1.0	1.0	1.0	ns
t_S	Setup Time, HIGH or LOW, DS_0 or DS_7 to CP	5.0	1.5	4.5	5.0	ns
t_H	Hold Time, HIGH or LOW, DS_0 or DS_7 to CP	5.0	–1.0	1.0	1.0	ns
t_W	CP Pulse Width, HIGH or LOW	5.0	2.0	4.0	4.5	ns
t_W	$\overline{MR}$ Pulse Width, LOW	5.0	2.0	3.5	3.5	ns
t_{REC}	Recovery Time, $\overline{MR}$ to CP	5.0	0	1.5	1.5	ns

Note

9. Voltage range 5.0 is 5.0V ± 0.5V.

Capacitance

Symbol	Parameter	Conditions	Typ.	Units
C_{IN}	Input Capacitance	V_{CC} = 5.0V	4.5	pF
C_{PD}	Power Dissipation Capacitance	V_{CC} = 5.5V	170	pF

Physical Dimensions

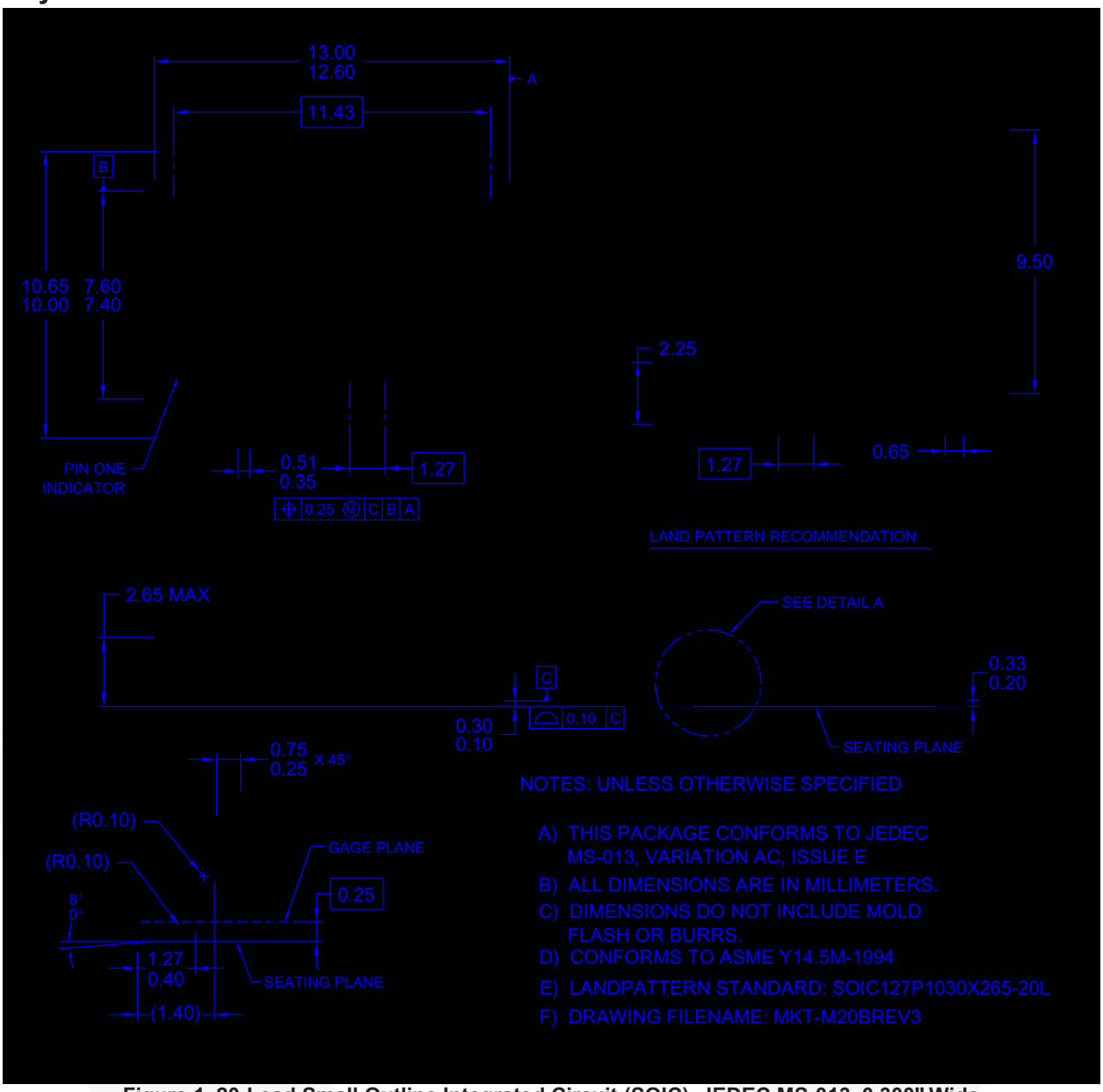


Figure 1. 20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide

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Physical Dimensions (Continued)

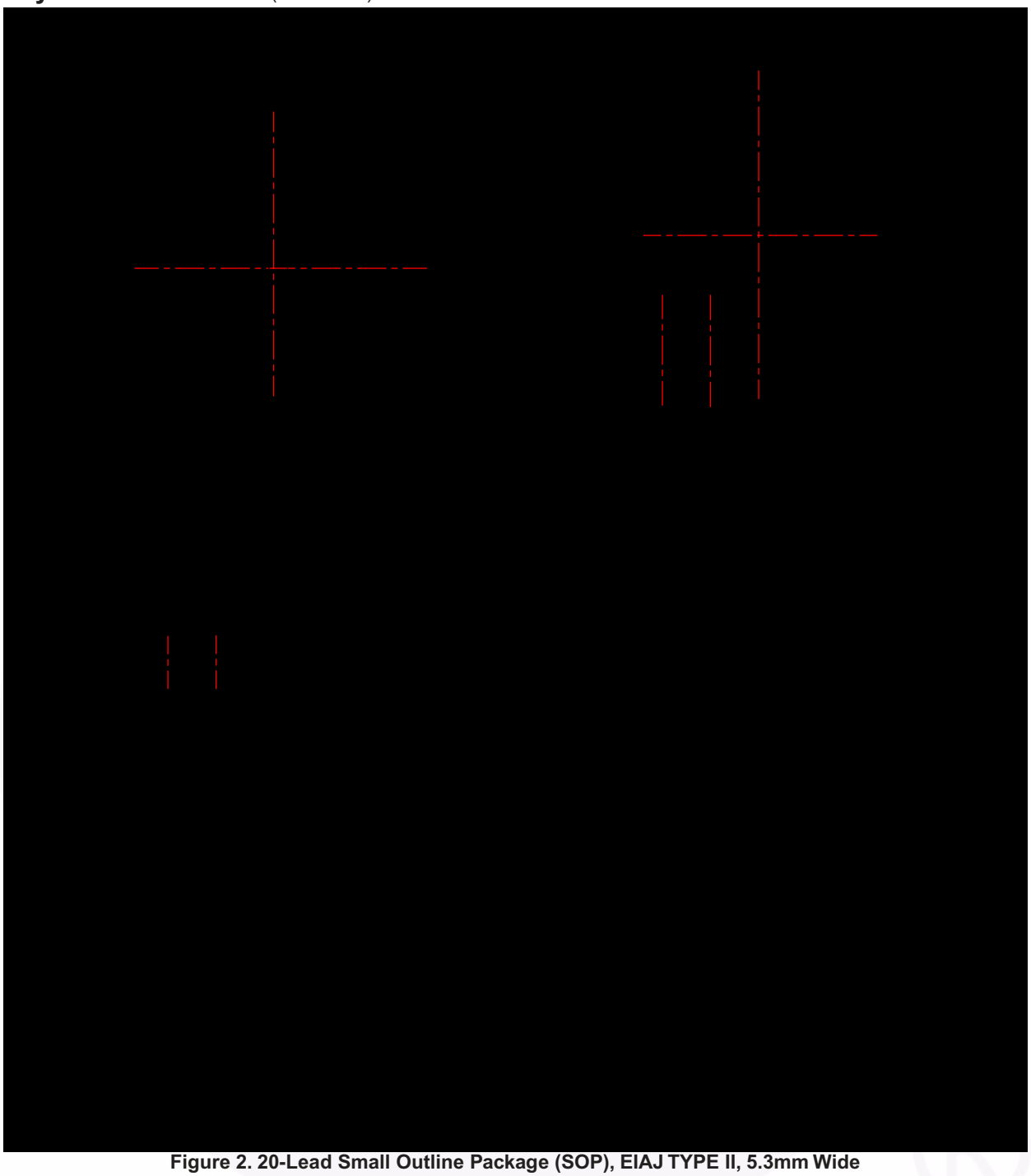

Figure 2. 20-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide

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Physical Dimensions (Continued)

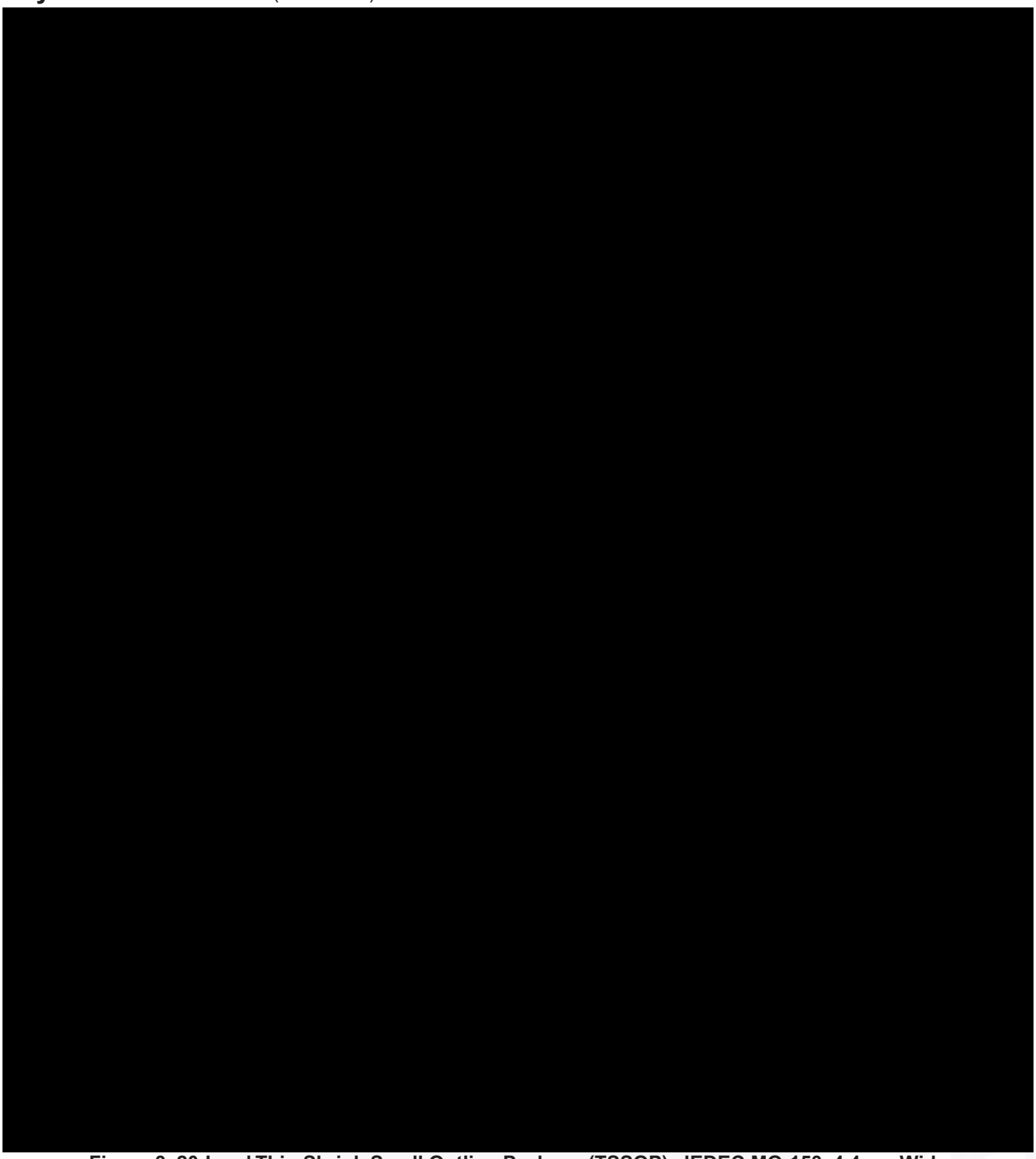

Figure 3. 20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide

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Physical Dimensions (Continued)

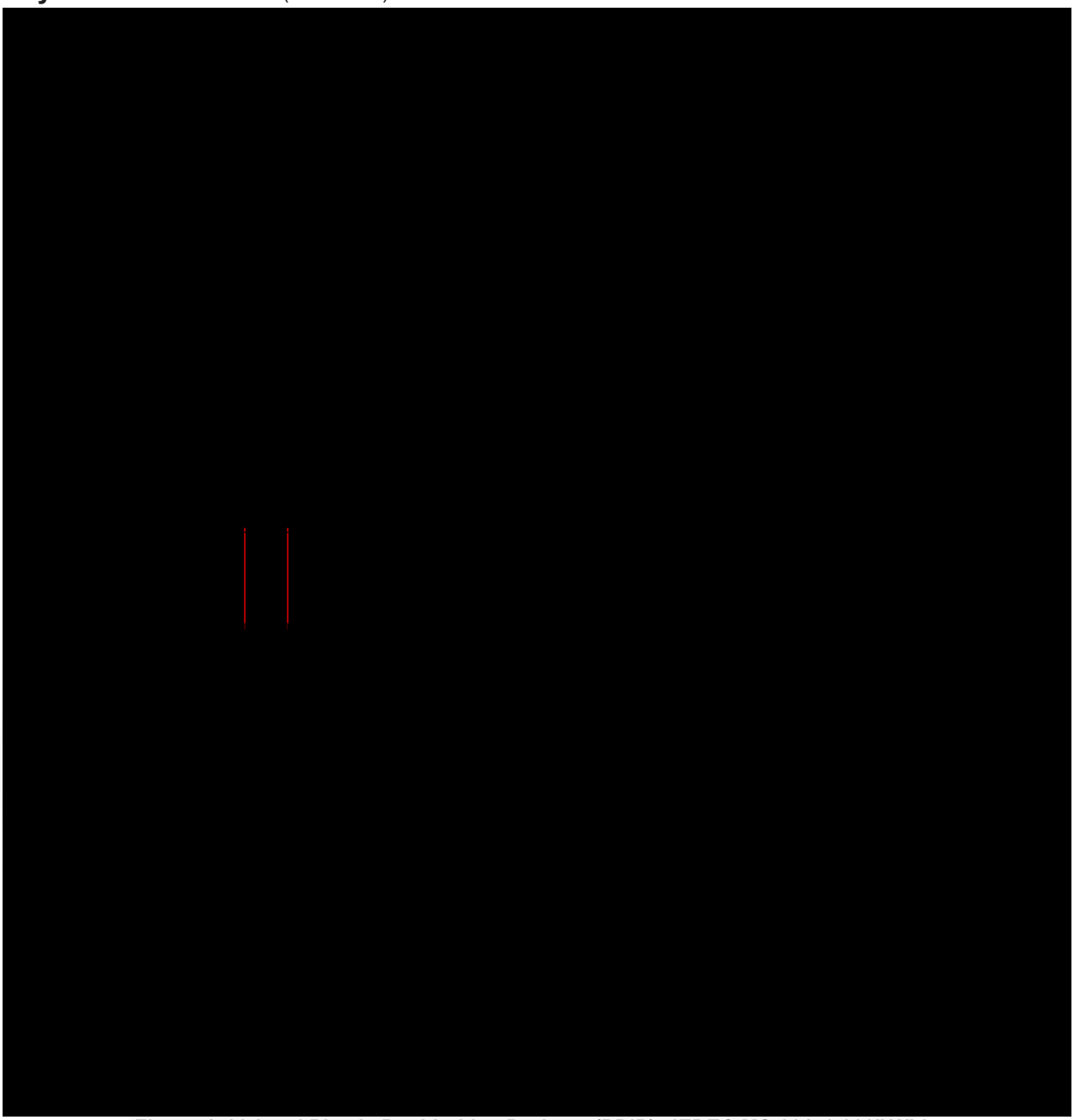

Figure 4. 20-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide

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Definition of Terms

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